

Institute of Polymer Nanotechnology (INKA)

Joint Venture: University of Applied Sciences & Paul-Scherrer Institute (PSI)

FHNW - IKT & INKA



Windisch

LMN - Laboratory for Micro- und Nanotechnology

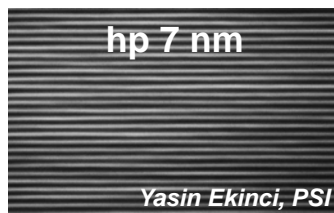
INKA

10 km



Synchrotron

Villigen



Applications and Challenges: Microfluidic Analysis Systems

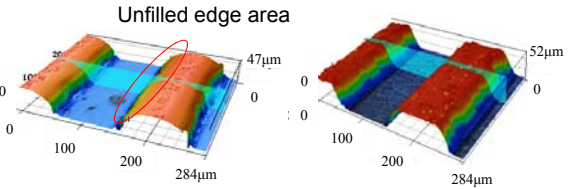


courtesy of Bernd Müller for IMTEK & Hahn-Schickard

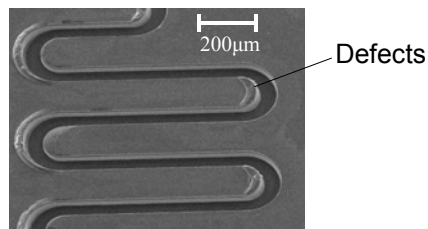
Lab-on-a-chip

Injection moulding issues:

1. Filling



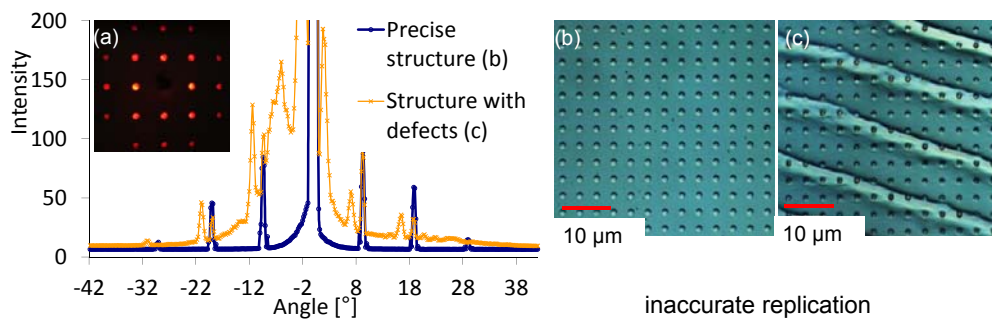
2. Demoulding



→ Strong impairment of functionality

Applications and Challenges: Optical applications

Optical diffraction pattern

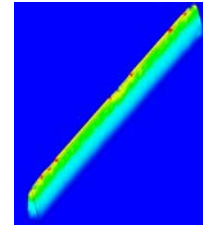


inaccurate replication
→ irregular optical signals

Low replication quality reduces functionality of polymer surfaces

Motivation for Simulation

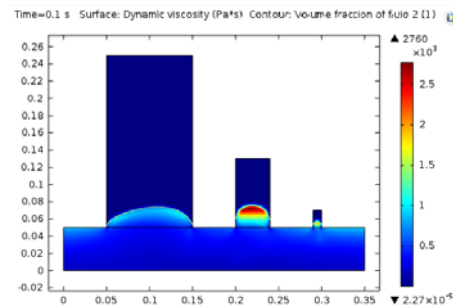
- **Fast prediction of filling behaviour**
→ Replication Ratio RR Master / Replica
- **Differences in materials**
→ no-flow temperature, viscosity
- **Different structure designs**
→ Width, height, aspect-ratio
- **Influence of processing parameters**
→ Mould temperature, injection speed, holding pressure...



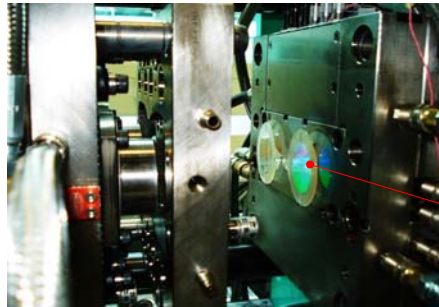
Better understanding of the filling process in general!

Content

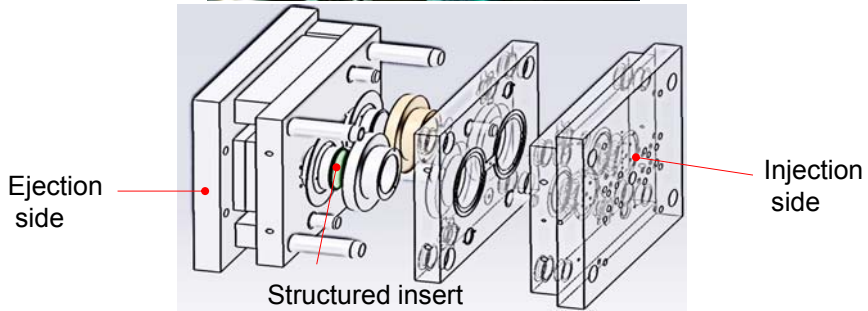
1. **Introduction: Applications**
2. **Motivation for simulation**
3. **Multiscale model idea**
4. **Correlation of simulation with injection moulding trials**
5. **Prerequisites for precise simulation**
6. **Conclusions and Outlook**



Injection Mould



Polymer part



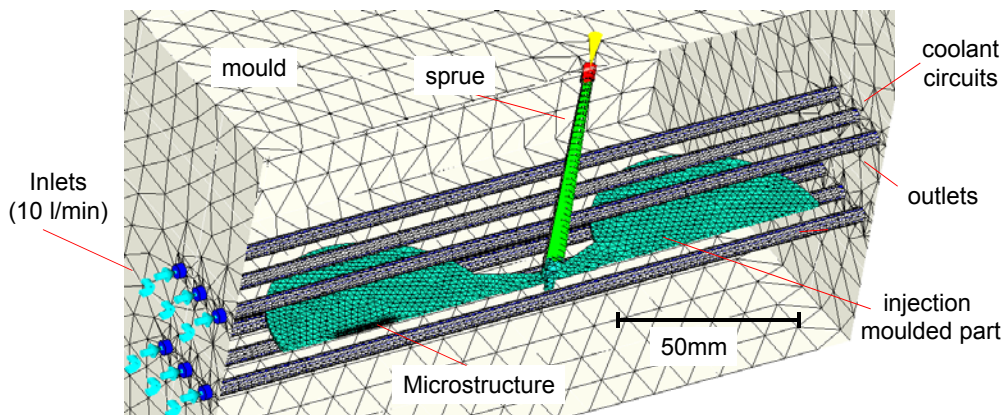
Ejection side

Injection side

Structured insert

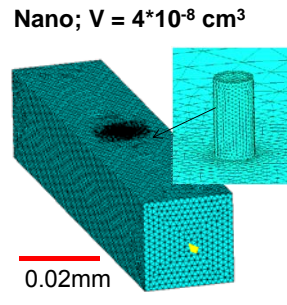
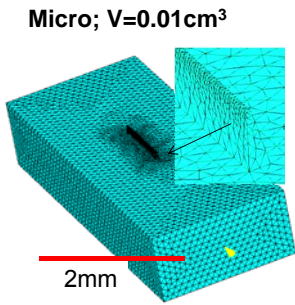
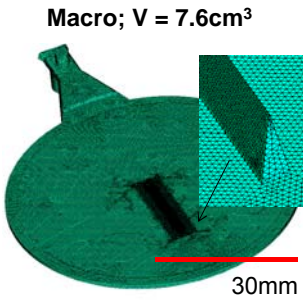
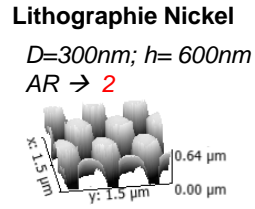
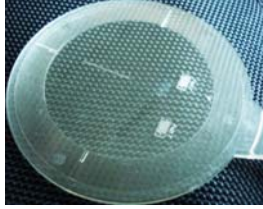
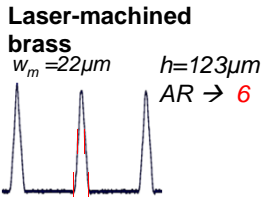
Moldflow Simulations: Analysis Sequences

1. **Filling:** Most important sequence
2. **Packing:** Influence of holding pressure
3. **Cooling:** Cooling circuit
4. **Warping:** Important on macro scale



Simplification: Filling and Packing → Reduction of calculation time

Model Approach

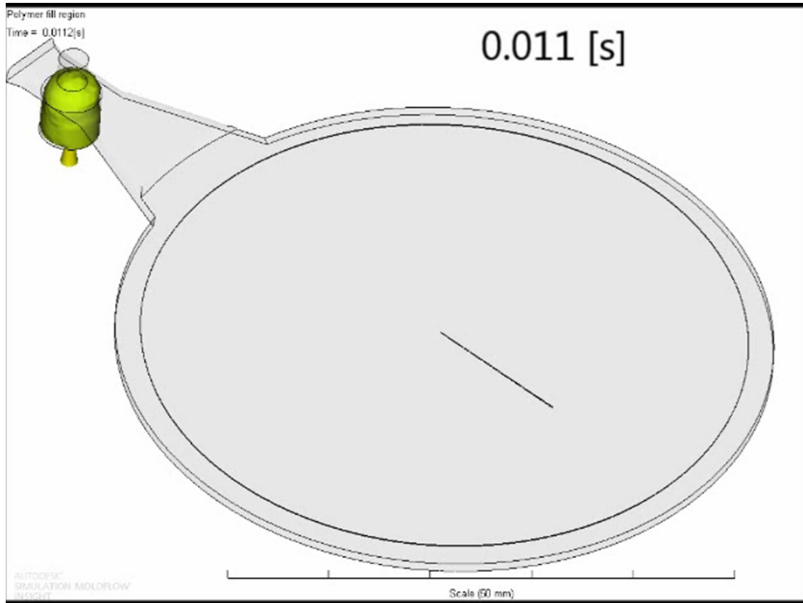


8.3 Mio elements \rightarrow 400h

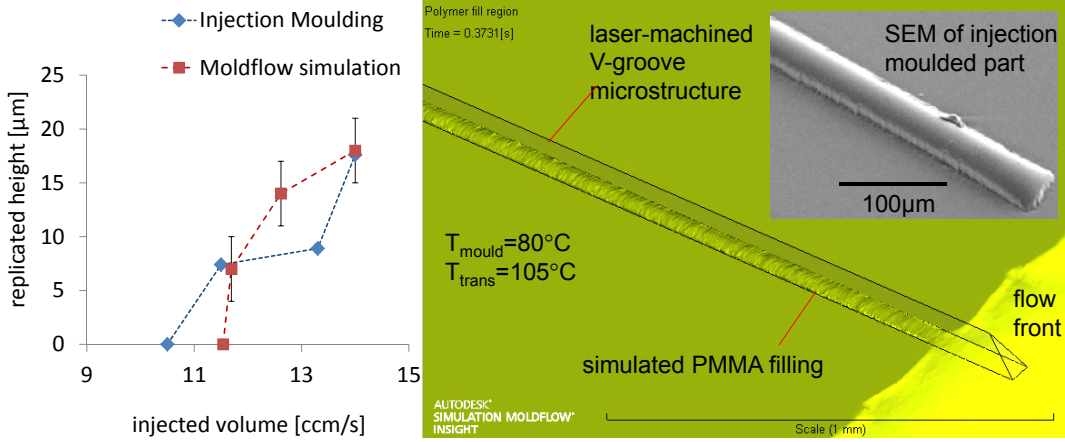
0.1 Mio elements \rightarrow 2h

0.3 Mio elements \rightarrow 4h

3D Simulation: V-Microgroove; PMMA $T_{\text{mould}} = 115^\circ\text{C}$

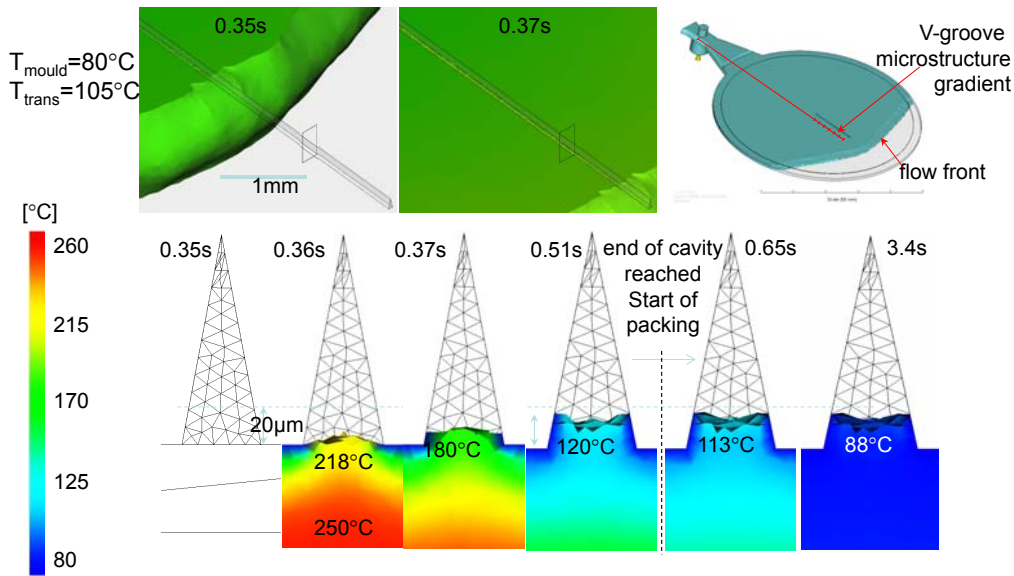


Short-Shots: PMMA, 15cm³/s



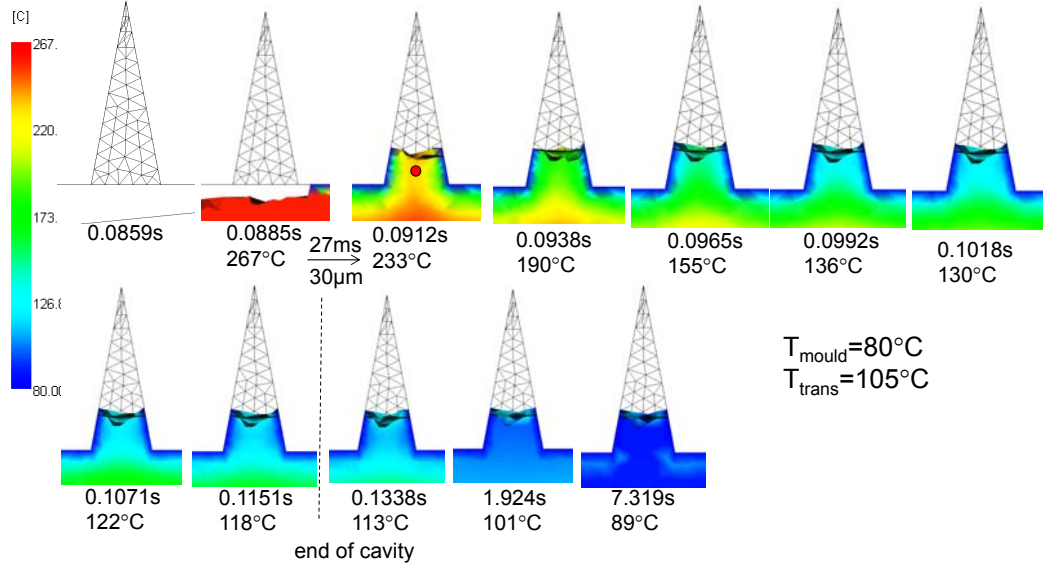
Good correlation of short-shots with simulation

Moldflow Simulation, PMMA, 15cm³/s



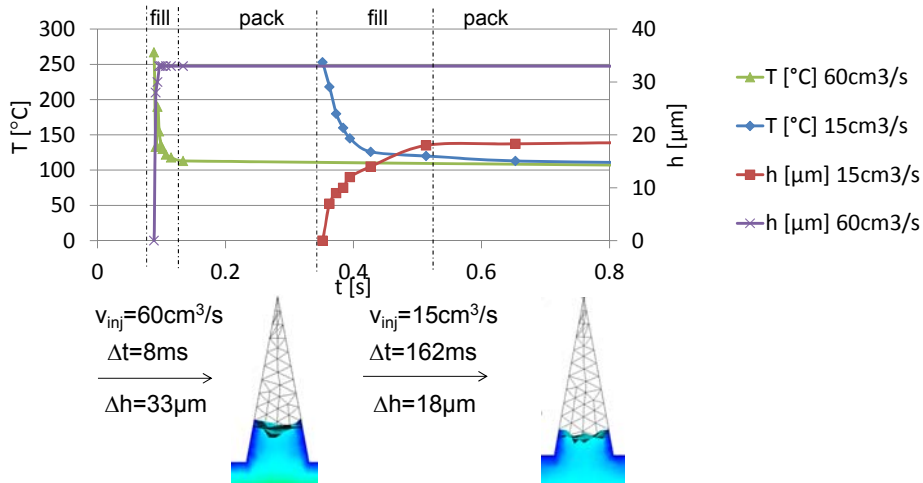
If $T_{\text{mould}} \ll T_{\text{trans}} \rightarrow$ filling takes place before packing

Moldflow Simulation, PMMA, 60cm³/s



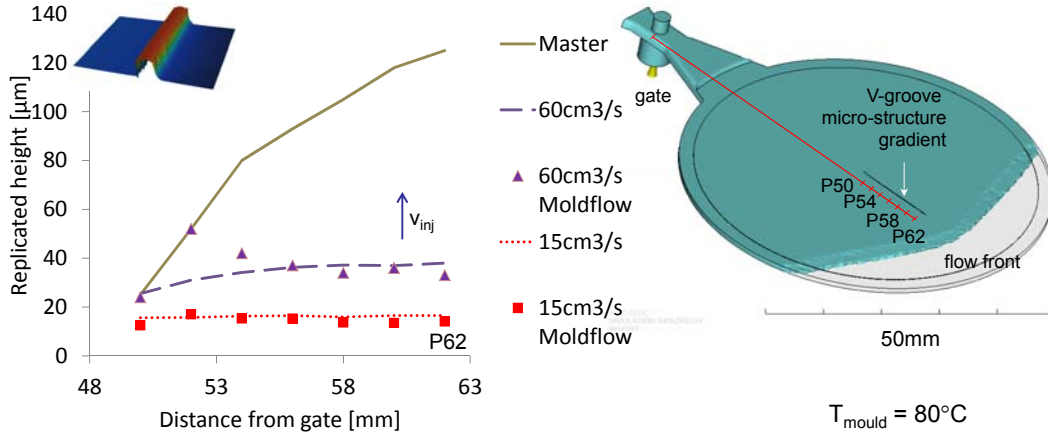
Much faster filling and cooling compared to $v_{inj}=15\text{cm}^3/\text{s}$

Moldflow Simulation PMMA - Comparison 15cm³/s vs. 60cm³/s



High injection speed:
very fast filling with higher melt temperature, but faster cooling

Comparison Simulation with Experiments

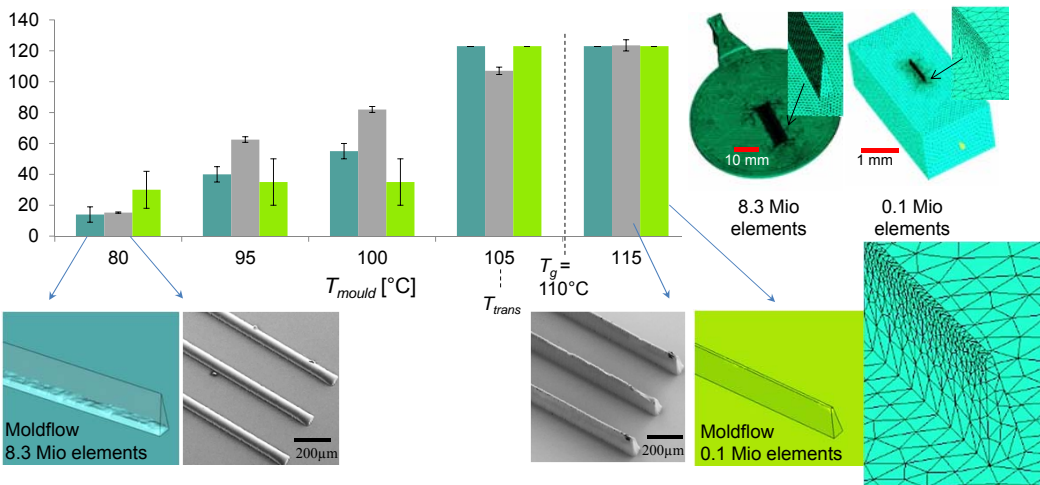


- Improved replication with higher injection speed
- Good correlation with Moldflow simulation for different v_{inj}

3D Simulation on Microscale: Influence of Mould Temperature

PMMA replica with v-groove microstructure

h_r [μm] ■ 8.3Mio elements ■ Injection Moulding ■ 0.1Mio elements

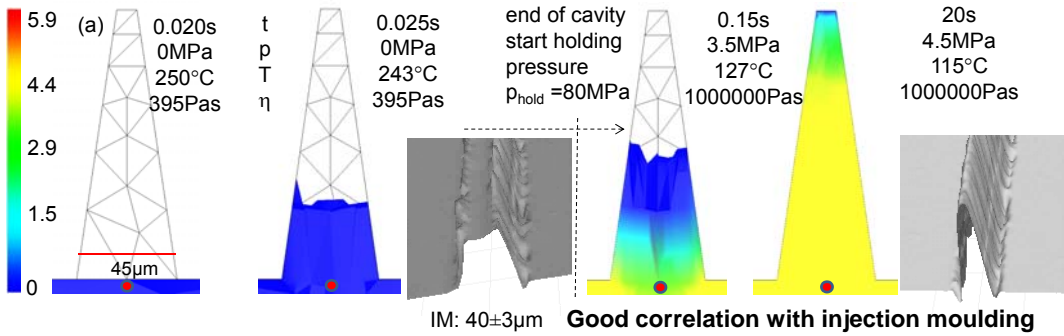


Good Correlation of simulation and experiments on microscale with 8.3 elements

Influence of holding pressure above Glass Transition Temperature

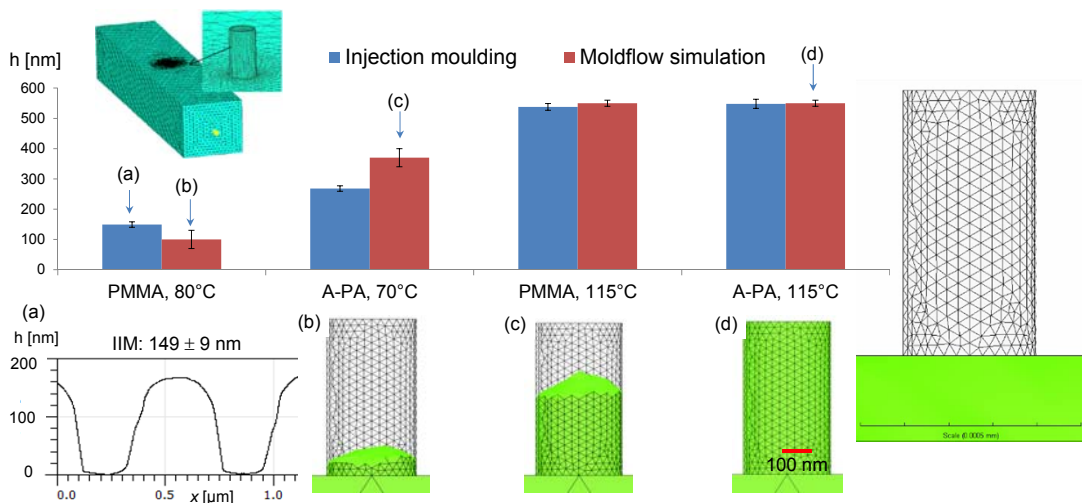
PMMA, $T_{\text{mould}}=115^{\circ}\text{C}$, $T_{\text{trans}}=105^{\circ}\text{C}$ $\text{HTC}=30000\text{W/m}^2\text{K}$

[Mpa]



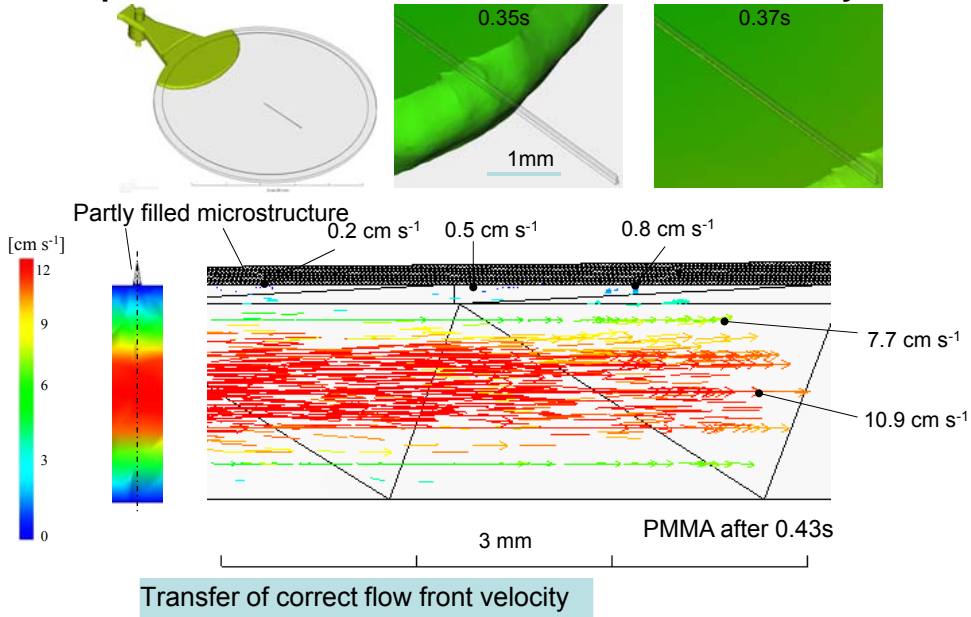
Packing stage: More important for variothermal process
→ cooling of polymer is delayed and material can be still pressed into the cavities

3D Simulation on Nanoscale: Influence of Mould Temperature



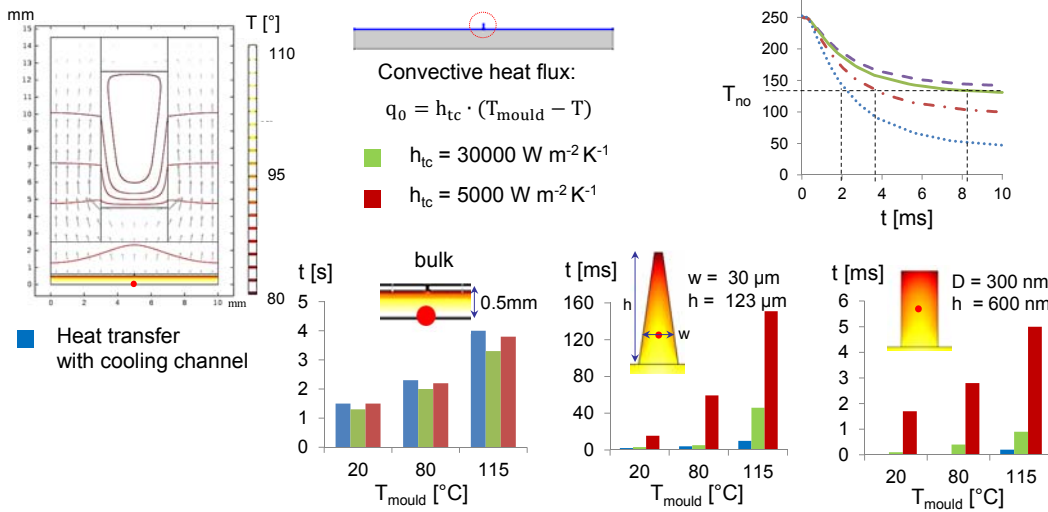
Good Correlation of simulation and experiments on nanoscale

Prerequisites for Correct Simulation: Flow front velocity



Prerequisites for Correct Simulation

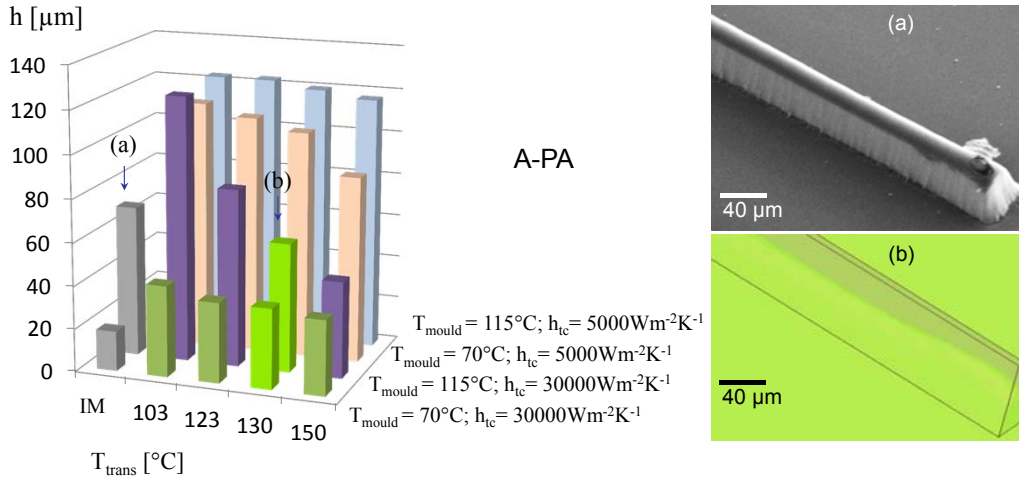
Increase of heat transfer coefficient



Heat transfer: nano >> micro >> macro

Prerequisites for Correct Simulation

Adaption of transition temperature to no-flow temperature

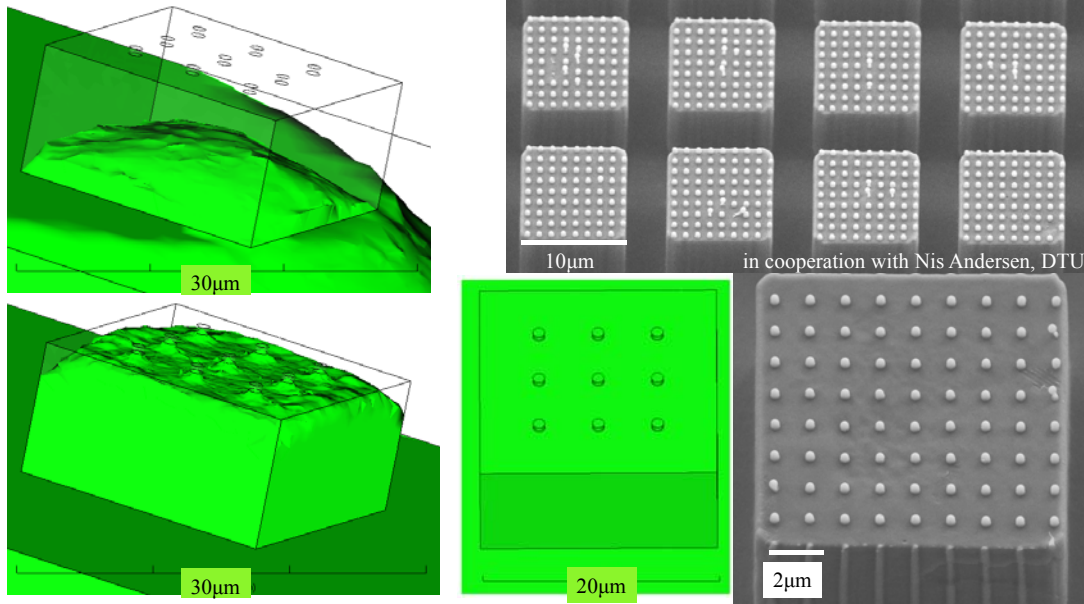


Correct T_{trans} is especially relevant for the holding pressure phase

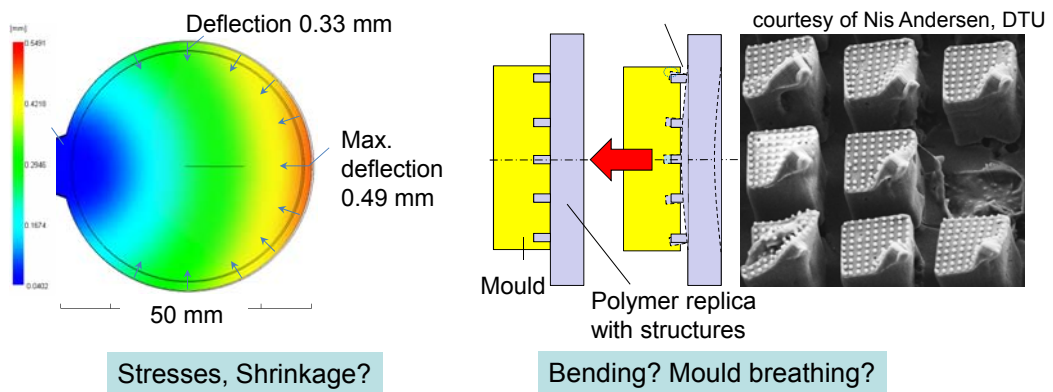
Summary / Conclusions

- Filling simulation of micro- and nanostructures: good correlation to experiments
→ For different materials and processing parameters, above and below T_g
→ Potential reduction of development time
- Most important for scaling:
→ Correct transfer of flow front velocity
→ Heat transfer coefficient and T_{no} have a significant influence on results
→ T_{trans} needs to be adapted to T_{no}
- T_{no} or T_{trans}
→ Especially influences variothermal replication in packing phase
→ Less effect on filling in isothermal process if $T_{mould} < T_{trans}$

Simulation of Hierarchical Micro- and Nanostructures



Outlook Demoulding



Research ongoing

Thank you for your attention!



Injection mouldings trials published in:

Rytka C., Kristiansen P.M., Neyer A., 2015

Iso- and variothermal injection compression moulding of polymer micro- and nanostructures for optical and medical applications, ***J. Micromech. Microeng.*** 25, 065008

Topic simulation published in:

Rytka C., Lungershausen J., Kristiansen P. M., Neyer A., 2016

3D filling simulation of micro- and nanostructures in comparison to injection moulding trials, ***J. Micromech. Microeng.*** 26, 065018